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Refrigeration 201

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September 2011



Key Learning's

- Review of Refrigeration 101
- Basic understanding of more complex components of a refrigeration system
- Overview of more complex mechanical refrigeration systems
- Interaction of the mechanical system with the building
- Equipment planning and location

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REFRIGERATION 101 REVIEW





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Refrigeration Cycle



LPV - Low Pressure Vapor LPL – Low Pressure Liquid HPV – High Pressure Vapor HPL – High Pressure Liquid

SYSTEM MAJOR COMPONENTS OVERVIEW







Reciprocating Compressor

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MEDIUM TEMP PRESSURES





- Moving pistons compress refrigerant gas within cylinders.
- On the downstroke, the suction inlet valve is open as low pressure gas refrigerant is drawn into the cylinder.
- When the piston begins its upstroke, the suction inlet valve is closed and pressure increases.
- High pressure gas exits through the discharge port .



Scroll Compressor



Intake Stationary Scroll Compression orbiting Scroll Compression after 1 rotation Compression after 2 rotations Discharge

- Rotation is critical on scroll compressors.
- An orbiting scroll moves in a circular motion within a second, fixed scroll.
- The gas entering the low pressure inlet is pressurized into continuously smaller areas until it exits through the discharge line.



Screw Compressor



^{2.} Auxiliary Rotor

Intake: the vapor passes through the inlet and into the void which is wide open at the suction end.

Compression: as the rotors contrarotate, the inlet void closes, the volume is reduced and the pressure increases.

Discharge: compression is completed, final pressure achieved and the vapor is discharged.







Round Tube Plate Fin (RTPF) Air Cooled Condenser

• Coil comprised of:

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- copper tubes to transport refrigerant
- aluminum fins to increase heat transfer capability

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• Fans pull ambient air across coil section



- Heat is rejected to atmosphere
- Refrigerant changes from superheated vapor to sub-cooled liquid





MicroChannel Air Cooled Condenser

- Same operation as RTPF air cooled condenser
- Coil comprised of:
 - flattened aluminum tube with narrow channels
 - aluminum fins in between
- Reduced refrigerant charge
- Smaller size with less weight





Evaporative Cooled Condenser

- Copper tubes transport refrigerant through coil slab
- Ambient air blown over coils
- Water from a sump is sprayed over the coils to increase heat removal



- Allows the condensing temperature to approach the wet bulb (WB) temperature of the ambient air versus the dry bulb (DB) temperature, which is normally higher.
- Increases system efficiency



Dry Fluid Cooler / Plate-to-Plate Condenser

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- Fan cooled coil assembly
- Draws ambient air across coil slab to remove heat from glycol mixture

- Glycol mixture used as condenser fluid for refrigeration system
- Refrigeration system uses heat exchanger (plate-toplate shown) to condense compressor discharge gas
 - Located near compressors





Hybrid Fluid Cooler / Condenser

- Uses RTPF coil or microchannel coil
- Equipped with pre-cooling pads to cool incoming ambient air with water that is distributed over the cooling pads



- Air is drawn through the cooling pads and the heat exchangers
- Increases system efficiency



Display Case Operation (DX)

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Display Case Operation (Secondary)

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through it (sensible heat) Removes humidity (latent heat) Low pressure liquid refrigerant is boiled off

- Low pressure liquid refrigerant is boiled off into low pressure vapor
- Proper airflow though the evaporator coil is critical to its function
- Moisture from ambient air freezes on coil tubes. This frost or ice prevents proper air flow across the coil and air curtain velocities.
- Defrost is the removal of frost or ice from an evaporator coil
 - •Off time MT Coils •Electric – LT / MT Coils •Hot Gas – LT / MT Coils •Cool Gas – LT / MT Coils •Warm Fluid – MT Glycol Coils

Display Case Equipment

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 Reduces the temperature of the air passing through it (sensible heat)









Case Temperature Control





Thermostatic Expansion Valve (TXV)

Electronic Expansion Valve (EEV)

- Expansion Valve (EV)
 - Regulates refrigerant flow
 - Maintains superheat at the evaporator outlet

Mechanical EPR w/solenoid



Electronic EPR (EEPR)

- Evaporator Pressure Regulator (EPR)
 - Maintain accurate display case pressure and temperature
 - Allows multiple evaporator systems to operate at different temperatures when piped to a common suction group





SYSTEM TYPES

2011 7. E+SC Energy & Store Development Conference FOOD MARKETING INSTITUTE **DX System Operation** LT Compressor **Cold Gas** (≈35°F) Hot Gas МΤ (≈250°F) Compressor Cold Gas 70% Liquid Condenser **R404A** (≈55°F) EEV 30% Gas Mix Case (15°F)

Warm Liquid (~105°F) Warm Liquid (~105°F) Warm (15°F) TXV 30% Gas Mix (15°F) TXV 30% Gas Mix (15°F) T0% Liquid 30% Gas Mix (15°F) Case Case Case

DX – Direct Expansion refrigeration system

DX Condensing Unit Equipment



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DX Rack Equipment (Circuit Piping)







DX Rack Equipment (Loop Piping)



Lower refrigerant charge than circuit piping





Distributed – Multiple small compressor units located close to their loads throughout the store



Secondary Glycol System Operation

* MT Only



Secondary – Intermediate medium for heat transfer between cooling load and refrigerant



Low refrigerant charge

Reduced leaks

Less Copper



Secondary CO₂ System Operation

* LT and MT





Cascade CO₂ DX System Operation

* LT Only



Cascade – Two independent refrigeration systems in series sharing a common heat exchanger





Ammonia (NH3) Primary System

•Primary Refrigeration Enclosure

Primary Refrigeration Loop

PLATE HEAT



- Typically used with secondary systems
 - Example range of operation (-60°F to +60°F)
- Displaces use of HFC's
- Can not be used with copper
- Use of water system for scrubbing in case of leak



SYSTEM & BUILDING INTERACTION





Water Heat Reclaim

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Heat Reclaim

- Uses available compressor heat to heat building water or air rather than rejecting to
 - · Good source for air reheat or dehumidification
 - Increases refrigerant charge





Split Condenser

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Split Condenser

- Condenser sized with two parallel coils (50% - 50%)
- In Winter operation, 50% of condenser is disabled
- Reduces capacity of condenser for proper system control in cold climates
- Controlled by ambient temp sensor
 - 25% 50% 50% split is also available

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Heat Reclaim & Split Condenser







•Enhances condenser performance

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Suction groups

Manages multiple compressor racks
Optimizes compressor cycling and energy savings

Microprocessor Controller

- •Central point of equipment control and monitoring
- Increases equipment life and energy with logical control algorithms
- •Allows equipment monitoring, alarming and optimization





Controller boards

•Expandable I/O system •Allows for multiple control and monitoring points



Refrigerant leak detectors

•Immediate notification when leak occurs

•Program multiple set points



Circuits/display cases Flexible control options to choose from Supports multiples of cases and case types





Tools Used by Engineers / Designers

ANALYSIS & COMPARISONS





Energy Analysis

• Energy Efficiency Ratio (EER)

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- Btu/hour per watt
- Coefficient of Performance (COP)

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- Unitless
- The amount of cooling divided by the power needed to do the cooling
- A higher value is better
 - it means less energy is used to do a given amount of cooling
- EER and COP depend on many factors
 - evaporating temperature
 - condensing temperature
 - size of condenser
 - type of compressor
 - etc



EER is heavily influenced by ambient temp:Hot dayCold day• COP = 2• COP = 5• EER = 7 Btu/hr/watt• EER = 17 Btu/hr/watt

Energy use is less than half on cold days



Ambient Temperature Bin Hours



Dry Bulb BIN Hour Comparison

Temperature (Deg F)





Temperature (Deg F)



Technology Comparison

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| Approach | Central DX | Distributed DX | Distributed Glycol Secondary | Central Glycol Secondary | Liquid Recirc CO ₂ | Cascade CO ₂ |
|--------------------------------|---------------|-------------------|------------------------------------|--------------------------------|----------------------------------|----------------------------|
| Equipment 1 st Cost | Baseline | | | | | |
| Energy Efficiency | Baseline | ÷ | | | | ÷ |
| Refrigerant Charge | Baseline | ÷ | + | ÷ | ÷ | ÷ |
| Total Cost of Ownership | Baseline | ÷ | | | | |
| Carbon Footprint | Baseline | ÷ | ÷ | ÷ | ÷ | ÷ |
| Service and Complexity | Baseline | ÷ | | | ÷ | |





| | $=+Sd^2$ | 2011 Energy & Store Development Conference | | | | |
|--------------------------------------|-------------------------------|--|--|--|--|--|
| SS-ENVIRONMENTAL PROTECTI GREENCH | ATTNERONN | | | | | |
| | System Type | Possible Level Attainable | | | | |
| | Distributed | Silver when air-cooled Gold when air-cooled with microchannel | | | | |
| | Secondary Distributed | Gold when air-cooled condenser Platinum when water-cooled | | | | |
| | MT Secondary Glycol | Silver with centralized LT DX Gold with other advanced LT | | | | |
| | Secondary CO ₂ | Gold when used for both LT & MT Loads | | | | |
| | LT CO ₂ Cascade | Gold when combined with MT secondary glycol or secondary CO_2 MT | | | | |
| | MT Glycol Compact Chiller | Platinum when water cooled and combined with LT CO_2 | | | | |
| | | | | | | |

Application of any system type does not guarantee certification ability. Proper planning, equipment selection, application, placement, and refrigerant are required.



Risk Increases Significantly w/ Product Temp





Listeria



•E Coli on Beef



•Note: Y axis is 1000's of colony forming units per gram. It only takes < 100 cells to cause illness

Why refrigeration is important - for the preservation and distribution of food...



Thank you for your attention!

Questions?

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